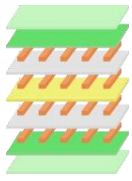
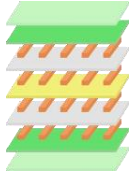
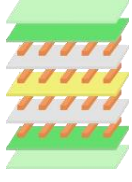
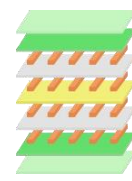
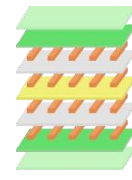


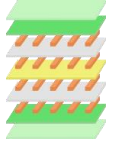
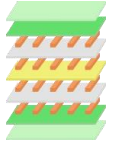
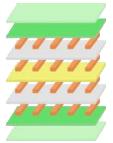
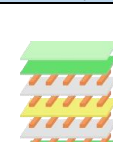
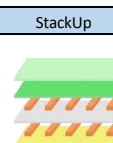
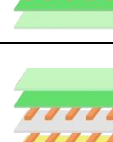
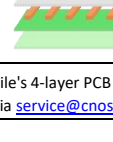


Oceansmile Multi-layer PCB Standard Stackup

4-Layer PCB Board

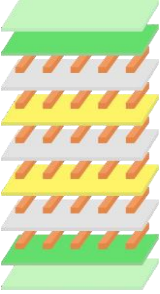
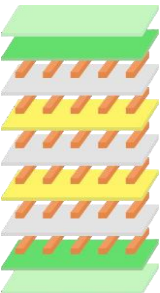
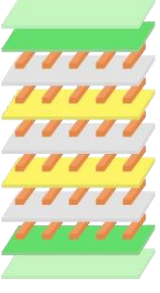
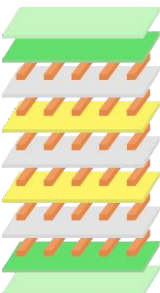
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
0.4mm±0.1mm	1/1oz		L1	Copper 18 um--plating to 35um
			L2	PP 0.08 mm dielectric constant 4.29
			L3	Core 0.2mm with 1/1 oz Cu
			L4	PP 0.08 mm dielectric constant 4.29
			L5	Copper 18 um--plating to 35um
			L6	PP 0.08 mm dielectric constant 4.29
			L7	Core 0.2mm with 1/1 oz Cu
			L8	PP 0.08 mm dielectric constant 4.29
0.6mm±0.1mm	1/1oz		L1	Copper 18 um--plating to 35um
			L2	PP 0.11 mm dielectric constant 4.29
			L3	Core 0.2mm with 1/1 oz Cu
			L4	PP 0.11 mm dielectric constant 4.29
			L5	Copper 18 um--plating to 35um
			L6	PP 0.11 mm dielectric constant 4.29
			L7	Core 0.3mm with 1/1 oz Cu
			L8	PP 0.11 mm dielectric constant 4.29
0.6mm±0.1mm	2/1oz		L1	Copper 18 um--plating to 35um
			L2	PP 0.11 mm dielectric constant 4.29
			L3	Core 0.2mm with 1/1 oz Cu
			L4	PP 0.11 mm dielectric constant 4.29
			L5	Copper 18 um--plating to 35um
			L6	PP 0.11 mm dielectric constant 4.29
			L7	Core 0.2mm with 1/1 oz Cu
			L8	PP 0.11 mm dielectric constant 4.29
0.8mm±0.1mm	1/1oz		L1	Copper 18 um--plating to 35um
			L2	PP 0.11 mm dielectric constant 4.29
			L3	Core 0.4mm with 1/1 oz Cu
			L4	PP 0.11 mm dielectric constant 4.29
			L5	Copper 18 um--plating to 35um
			L6	PP 0.11 mm dielectric constant 4.29
			L7	Core 0.4mm with 1/1 oz Cu
			L8	PP 0.11 mm dielectric constant 4.29
0.8mm±0.1mm	2/1oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.11 mm dielectric constant 4.29
			L3	Core 0.4mm with 1/1 oz Cu
			L4	PP 0.11 mm dielectric constant 4.29
			L5	Copper 50um(±5)um-plating to 70um
			L6	PP 0.11 mm dielectric constant 4.29
			L7	Core 0.3mm with 1/1 oz Cu
			L8	PP 0.18 mm dielectric constant 4.29
0.8mm±0.1mm	1/1oz		L1	Copper 18 um--plating to 35um
			L2	PP 0.18 mm dielectric constant 4.29
			L3	Core 0.3mm with 1/1 oz Cu
			L4	PP 0.18 mm dielectric constant 4.29
			L5	Copper 18 um--plating to 35um
			L6	PP 0.18 mm dielectric constant 4.29
			L7	Core 0.2mm with 1.5/1.5 oz Cu
			L8	PP 0.22 mm dielectric constant 4.29
0.8mm±0.1mm	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.22 mm dielectric constant 4.29
			L3	Core 0.2mm with 1.5/1.5 oz Cu
			L4	PP 0.22 mm dielectric constant 4.29
			L5	Copper 50um(±5)um-plating to 70um
			L6	PP 0.22 mm dielectric constant 4.29
			L7	Core 0.2mm with 1.5/1.5 oz Cu
			L8	Copper 50um(±5)um-plating to 70um

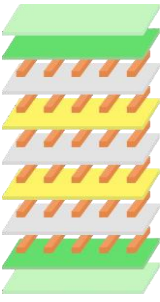
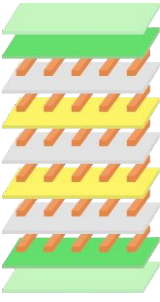
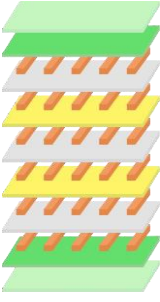
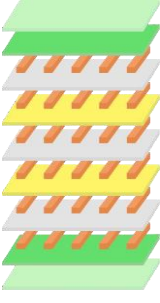
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.0mm±0.1mm	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.6mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	Copper 18 um--plating to 35um
1.0mm±0.1mm	2/1oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.6mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	Copper 50um(±5)um-plating to 70um
1.0mm±0.1mm	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.22 mm dielectric constant 4.29
			L2	
				Core 0.4mm with 1.5/1.5 oz Cu
			L3	
				PP 0.22 mm dielectric constant 4.29
			L4	Copper 50um(±5)um-plating to 70um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.2mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.8mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	Copper 18 um--plating to 35um
1.2mm±10%	2/1oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.8mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	Copper 50um(±5)um-plating to 70um
1.2mm±10%	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.22 mm dielectric constant 4.29
			L2	
				Core 0.6mm with 1.5/1.5 oz Cu
			L3	
				PP 0.22 mm dielectric constant 4.29
			L4	Copper 50um(±5)um-plating to 70um

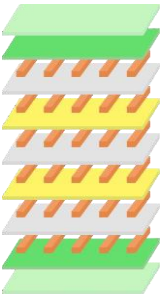
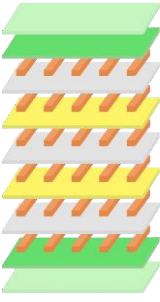
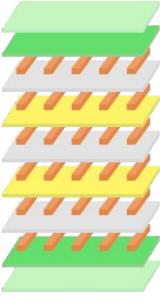
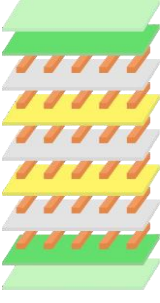
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.6mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 1.2mm with 1/1 oz Cu
			L3	
1.6mm±10%	2/1oz		L4	PP 0.11 mm dielectric constant 4.29
			L1	Copper 18 um--plating to 35um
				Copper 50um(±5)um-plating to 70um
				PP 0.11 mm dielectric constant 4.29
			L2	
1.6mm±10%	2/1.5oz			Core 1.2mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	Copper 50um(±5)um-plating to 70um
				Copper 50um(±5)um-plating to 70um
1.6mm±10%	2/1.5oz			PP 0.22 mm dielectric constant 4.29
			L1	Copper 50um(±5)um-plating to 70um
				PP 0.22 mm dielectric constant 4.29
			L2	
				Core 1mm with 1.5/1.5 oz Cu
2.0mm±10%	1/1oz		L3	
				PP 0.18 mm dielectric constant 4.29
			L4	Copper 18 um--plating to 35um
				Copper 18 um--plating to 35um
			L1	Copper 50um(±5)um-plating to 70um
2.0mm±10%	2/1oz			PP 0.11 mm dielectric constant 4.29
			L2	
				Core 1.6mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
2.0mm±10%	2/1.5oz		L4	Copper 50um(±5)um-plating to 70um
				Copper 50um(±5)um-plating to 70um
			L1	PP 0.29 mm dielectric constant 4.29
			L2	
2.0mm±10%	2/1.5oz			Core 1.2mm with 1.5/1.5 oz Cu
			L3	
				PP 0.29 mm dielectric constant 4.29
			L4	Copper 50um(±5)um-plating to 70um
				Copper 50um(±5)um-plating to 70um
2.4mm±10%	1/1oz			PP 0.36 mm dielectric constant 4.29
			L1	Copper 50um(±5)um-plating to 70um
				PP 0.36 mm dielectric constant 4.29
			L2	
				Core 1.6mm with 1.5/1.5 oz Cu
2.4mm±10%	2/1.5oz		L3	
				PP 0.36 mm dielectric constant 4.29
			L4	Copper 50um(±5)um-plating to 70um
				Copper 50um(±5)um-plating to 70um
			L1	

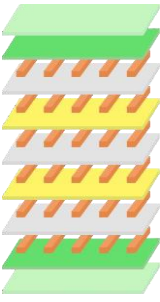
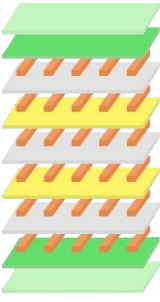
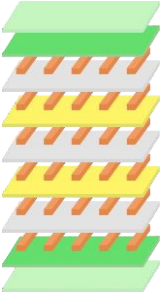
Note: The above is the standard stackup of Oceansmile's 4-layer PCB board, we may change the layer stackup according to latest material or technology. For more details. The custom stackup is available, feel free to contact us via service@cnospcb.com.

6-Layer PCB Board

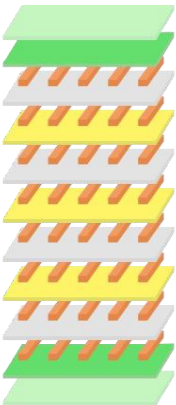
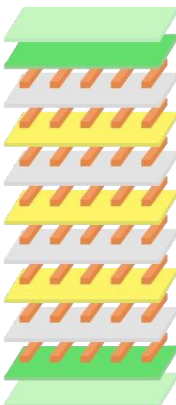
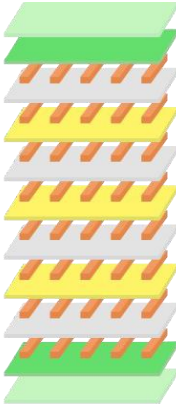
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
0.8mm ±0.1mm	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.2mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	
				Core 0.2mm with 1/1 oz Cu
			L5	
				PP 0.11 mm dielectric constant 4.29
			L6	Copper 18 um--plating to 35um
1.0mm ±0.1mm	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.18 mm dielectric constant 4.29
			L2	
				Core 0.2mm with 1/1 oz Cu
			L3	
				PP 0.18 mm dielectric constant 4.29
			L4	
				Core 0.2mm with 1/1 oz Cu
			L5	
				PP 0.18 mm dielectric constant 4.29
			L6	Copper 18 um--plating to 35um
1.0mm ±0.1mm	2/1oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.2mm with 1/1 oz Cu
			L3	
				PP 0.22 mm dielectric constant 4.29
			L4	
				Core 0.2mm with 1/1 oz Cu
			L5	
				PP 0.11 mm dielectric constant 4.29
			L6	Copper 50um(±5)um-plating to 70um
1.2mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.4mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	
				Core 0.4mm with 1/1 oz Cu
			L5	
				PP 0.11 mm dielectric constant 4.29
			L6	Copper 18 um--plating to 35um

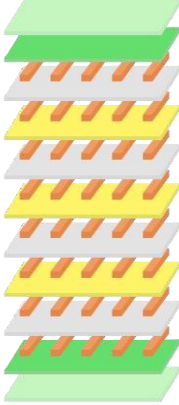
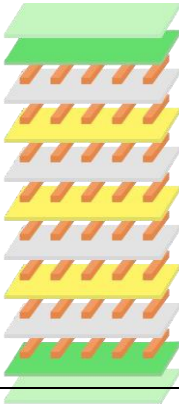
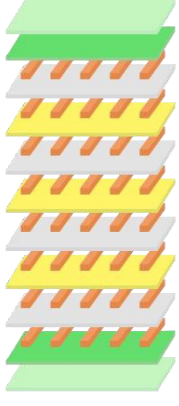
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.2mm±10%	2/1oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.18 mm dielectric constant 4.29
			L3	Core 0.2mm with 1/1 oz Cu
			L4	PP 0.18 mm dielectric constant 4.29
			L5	Core 0.2mm with 1/1 oz Cu
			L6	PP 0.18 mm dielectric constant 4.29
			L6	Copper 50um(±5)um-plating to 70um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.2mm±10%	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.22 mm dielectric constant 4.29
			L3	Core 0.2mm with 1.5/1.5 oz Cu
			L4	PP 0.22 mm dielectric constant 4.29
			L5	Core 0.2mm with 1.5/1.5 oz Cu
			L6	PP 0.22 mm dielectric constant 4.29
			L6	Copper 50um(±5)um-plating to 70um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.6mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
			L2	PP 0.11 mm dielectric constant 4.29
			L3	Core 0.6mm with 1/1 oz Cu
			L4	PP 0.11 mm dielectric constant 4.29
			L5	Core 0.6mm with 1/1 oz Cu
			L6	PP 0.11 mm dielectric constant 4.29
			L6	Copper 18 um--plating to 35um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.6mm±10%	2/1oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.18 mm dielectric constant 4.29
			L3	Core 0.4mm with 1/1 oz Cu
			L4	PP 0.18 mm dielectric constant 4.29
			L5	Core 0.4mm with 1/1 oz Cu
			L6	PP 0.18 mm dielectric constant 4.29
			L6	Copper 50um(±5)um-plating to 70um

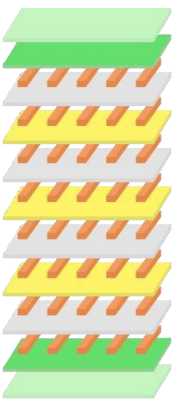
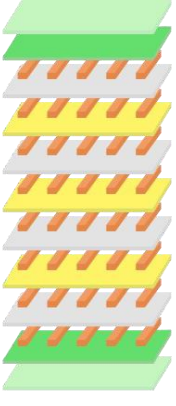
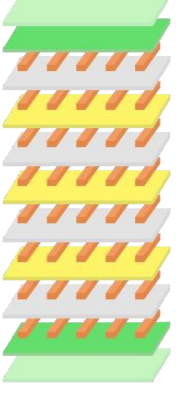
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.6mm±10%	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.22 mm dielectric constant 4.29
			L3	Core 0.4mm with 1.5/1.5 oz Cu
			L4	PP 0.22 mm dielectric constant 4.29
			L5	Core 0.4mm with 1.5/1.5 oz Cu
			L6	PP 0.22 mm dielectric constant 4.29
			L6	Copper 50um(±5)um-plating to 70um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
2.0mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
			L2	PP 0.11 mm dielectric constant 4.29
			L3	Core 0.8mm with 1/1 oz Cu
			L4	PP 0.11 mm dielectric constant 4.29
			L5	Core 0.8mm with 1/1 oz Cu
			L6	PP 0.11 mm dielectric constant 4.29
			L6	Copper 18 um--plating to 35um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
2.0mm±10%	2/1oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.11 mm dielectric constant 4.29
			L3	Core 0.8mm with 1/1 oz Cu
			L4	PP 0.11 mm dielectric constant 4.29
			L5	Core 0.8mm with 1/1 oz Cu
			L6	PP 0.11 mm dielectric constant 4.29
			L6	Copper 50um(±5)um-plating to 70um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
2.0mm±10%	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.22 mm dielectric constant 4.29
			L3	Core 0.6mm with 1.5/1.5 oz Cu
			L4	PP 0.22 mm dielectric constant 4.29
			L5	Core 0.6mm with 1.5/1.5 oz Cu
			L6	PP 0.22 mm dielectric constant 4.29
			L6	Copper 50um(±5)um-plating to 70um

Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
2.4mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
			L2	PP 0.11 mm dielectric constant 4.29
			L3	Core 1.0mm with 1/1 oz Cu
			L4	PP 0.11 mm dielectric constant 4.29
			L5	Core 1.0mm with 1/1 oz Cu
			L6	PP 0.11 mm dielectric constant 4.29
			L6	Copper 18 um--plating to 35um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
2.4mm±10%	2/1oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.11 mm dielectric constant 4.29
			L3	Core 1.0mm with 1/1 oz Cu
			L4	PP 0.11 mm dielectric constant 4.29
			L5	Core 1.0mm with 1/1 oz Cu
			L6	PP 0.11 mm dielectric constant 4.29
			L6	Copper 50um(±5)um-plating to 70um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
2.4mm±10%	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
			L2	PP 0.22 mm dielectric constant 4.29
			L3	Core 0.8mm with 1.5/1.5 oz Cu
			L4	PP 0.22 mm dielectric constant 4.29
			L5	Core 0.8mm with 1.5/1.5 oz Cu
			L6	PP 0.22 mm dielectric constant 4.29
			L6	Copper 50um(±5)um-plating to 70um

Note: The above is the standard stackup of Oceansmile's 6-layer PCB board, we may change the layer stackup according to latest material or technology. For more details, the custom stackup is available, feel free to contact us via service@cnospcb.com.

8-Layer PCB Board				
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.0mm±0.1mm	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.2mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	
				Core 0.2mm with 1/1 oz Cu
			L5	
				PP 0.11 mm dielectric constant 4.29
			L6	
				Core 0.2mm with 1/1 oz Cu
			L7	
				PP 0.11 mm dielectric constant 4.29
			L8	Copper 18 um--plating to 35um
Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.2mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.2mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	
				Core 0.2mm with 1/1 oz Cu
			L5	
				PP 0.11 mm dielectric constant 4.29
			L6	
				Core 0.2mm with 1/1 oz Cu
			L7	
				PP 0.11 mm dielectric constant 4.29
			L8	Copper 18 um--plating to 35um
1.2mm±10%	2/1oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.2mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	
				Core 0.2mm with 1/1 oz Cu
			L5	
				PP 0.11 mm dielectric constant 4.29
			L6	
				Core 0.2mm with 1/1 oz Cu
			L7	
				PP 0.11 mm dielectric constant 4.29
			L8	Copper 50um(±5)um-plating to 70um

Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
1.6mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.18 mm dielectric constant 4.29
			L2	
				Core 0.2mm with 1/1 oz Cu
			L3	
				PP 0.18 mm dielectric constant 4.29
			L4	
				Core 0.2mm with 1/1 oz Cu
			L5	
				PP 0.18 mm dielectric constant 4.29
			L6	
				Core 0.2mm with 1/1 oz Cu
			L7	
				PP 0.18 mm dielectric constant 4.29
			L8	Copper 18 um--plating to 35um
1.6mm±10%	2/1oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.18 mm dielectric constant 4.29
			L2	
				Core 0.2mm with 1/1 oz Cu
			L3	
				PP 0.18 mm dielectric constant 4.29
			L4	
				Core 0.2mm with 1/1 oz Cu
			L5	
				PP 0.18 mm dielectric constant 4.29
			L6	
				Core 0.2mm with 1/1 oz Cu
			L7	
				PP 0.18 mm dielectric constant 4.29
			L8	Copper 50um(±5)um-plating to 70um
1.6mm±10%	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.22 mm dielectric constant 4.29
			L2	
				Core 0.2mm with 1.5/1.5 oz Cu
			L3	
				PP 0.22 mm dielectric constant 4.29
			L4	
				Core 0.2mm with 1.5/1.5 oz Cu
			L5	
				PP 0.22 mm dielectric constant 4.29
			L6	
				Core 0.2mm with 1.5/1.5 oz Cu
			L7	
				PP 0.22 mm dielectric constant 4.29
			L8	Copper 50um(±5)um-plating to 70um

Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
2.0mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.18 mm dielectric constant 4.29
			L2	
				Core 0.4mm with 1/1 oz Cu
			L3	
				PP 0.18 mm dielectric constant 4.29
			L4	
				Core 0.4mm with 1/1 oz Cu
			L5	
				PP 0.18 mm dielectric constant 4.29
			L6	
				Core 0.4mm with 1/1 oz Cu
			L7	
				PP 0.18 mm dielectric constant 4.29
			L8	Copper 18 um--plating to 35um
2.0mm±10%	2/1oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.18 mm dielectric constant 4.29
			L2	
				Core 0.4mm with 1/1 oz Cu
			L3	
				PP 0.18 mm dielectric constant 4.29
			L4	
				Core 0.4mm with 1/1 oz Cu
			L5	
				PP 0.18 mm dielectric constant 4.29
			L6	
				Core 0.4mm with 1/1 oz Cu
			L7	
				PP 0.18 mm dielectric constant 4.29
			L8	Copper 50um(±5)um-plating to 70um
2.0mm±10%	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.19 mm dielectric constant 4.29
			L2	
				Core 0.4mm with 1.5/1.5 oz Cu
			L3	
				PP 0.19 mm dielectric constant 4.29
			L4	
				Core 0.4mm with 1.5/1.5 oz Cu
			L5	
				PP 0.19 mm dielectric constant 4.29
			L6	
				Core 0.4mm with 1.5/1.5 oz Cu
			L7	
				PP 0.19 mm dielectric constant 4.29
			L8	Copper 50um(±5)um-plating to 70um

Thickness	Copper thick (outer/inner)	StackUp	Layer No.	Laminated chart Thickness
2.4mm±10%	1/1oz		L1	Copper 18 um--plating to 35um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.6mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	
				Core 0.6mm with 1/1 oz Cu
			L5	
				PP 0.11 mm dielectric constant 4.29
			L6	
				Core 0.6mm with 1/1 oz Cu
			L7	
				PP 0.11 mm dielectric constant 4.29
			L8	Copper 18 um--plating to 35um
2.4mm±10%	2/1oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.11 mm dielectric constant 4.29
			L2	
				Core 0.4mm with 1/1 oz Cu
			L3	
				PP 0.11 mm dielectric constant 4.29
			L4	
				Core 0.6mm with 1/1 oz Cu
			L5	
				PP 0.11 mm dielectric constant 4.29
			L6	
				Core 0.6mm with 1/1 oz Cu
			L7	
				PP 0.11 mm dielectric constant 4.29
			L8	Copper 50um(±5)um-plating to 70um
2.4mm±10%	2/1.5oz		L1	Copper 50um(±5)um-plating to 70um
				PP 0.29 mm dielectric constant 4.29
			L2	
				Core 0.4mm with 1.5/1.5 oz Cu
			L3	
				PP 0.29 mm dielectric constant 4.29
			L4	
				Core 0.4mm with 1.5/1.5 oz Cu
			L5	
				PP 0.29 mm dielectric constant 4.29
			L6	
				Core 0.4mm with 1.5/1.5 oz Cu
			L7	
				PP 0.29 mm dielectric constant 4.29
			L8	Copper 50um(±5)um-plating to 70um

Note: The above is the standard stackup of Oceansmile's 8-layer PCB board, we may change the layer stackup according to latest material or technology. For more details, the custom stackup is available, feel free to contact us via service@cnoispb.com.